Special Issue

Advances in Thermoelectric Materials and Technologies

Message from the Guest Editors

This Special Issue seeks original research and review articles in the latest TE and TEG research, including high-performance TE materials, efficient and reliable device design and integration, and practical applications of TE in various fields. Topics covered include but are not limited to:

- Advance thermoelectric materials—synthesis and characterization
- Novel thermoelectric devices—design, engineering, and integration
- Strategies to enhance thermoelectric efficiency and performance
- Machine learning in thermoelectric materials research
- Machine learning approaches for green energy extraction for sustainable development
- Recent thermoelectric system and applications
- Thermoelectric applications in sustainable energy area
- Concentrated solar thermal thermoelectric design

Guest Editors

Dr. Akhtar Naureen

Department of Engineering Sciences, University of Agder, 4630 Kristiansand, Norway

Dr. Huey Hoon Hng

School of Materials Science and Engineering, Nanyang Technological University, Block N4.1, Nanyang Avenue, Singapore 639798, Singapore

Deadline for manuscript submissions

closed (20 June 2024)



Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



mdpi.com/si/136700

Applied Sciences Editorial Office MDPI, Grosspeteranlage 5 4052 Basel, Switzerland Tel: +41616837734 applsci@mdpi.com

mdpi.com/journal/applsci





Applied Sciences

an Open Access Journal by MDPI

Impact Factor 2.5 CiteScore 5.5



About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo

Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32, 20133 Milano, Italy

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility:

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, CAPlus / SciFinder, and other databases.

Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)

